

# 9575-VB SOT223-3 Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}$ ( $\Omega$ )	Ω) I <sub>D</sub> (A) <sup>a</sup>				
- 60	$0.055 \text{ at V}_{GS} = -10 \text{ V}$	- 7.0	30 nC			
- 00	0.065 at V <sub>GS</sub> = - 4.5 V	- 6.0	30110			

#### **FEATURES**

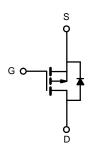
- Trench Power MOSFET
- 100 % UIS Tested

#### **APPLICATIONS**

Load Switch







P-Channel MOSFET

<b>ABSOLUTE MAXIMUM RATINGS</b>	(T <sub>A</sub> = 25 °C, unle	ess otherwise no	ted)	
Parameter		Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	- 60	V	
Gate-Source Voltage		V <sub>GS</sub>	± 20	v
	T <sub>C</sub> = 25 °C		- 7.0 <sup>a</sup>	
Continuous Drain Current (T <sub>.I</sub> = 150 °C)	T <sub>C</sub> = 70 °C		- 5.2	
Continuous Diain Current (1 <sub>J</sub> = 130°C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 4.8 <sup>b</sup>	A
	T <sub>A</sub> = 70 °C		- 4.1 <sup>b</sup>	
Pulsed Drain Current		I <sub>DM</sub>	- 25	
Avalanche Current Pulse	L = 0.1 mH	I <sub>AS</sub>	- 4.5	
Single Pulse Avalanche Energy	L = 0.111111	E <sub>AS</sub>	10.1	mJ
Ocaliana Canada Basis Bisda Osarad	T <sub>C</sub> = 25 °C	I.	6.9 <sup>a</sup>	A
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	3.5 <sup>b</sup>	
	T <sub>C</sub> = 25 °C		10.4 <sup>a</sup>	
Maximum Power Dissipation	T <sub>C</sub> = 70 °C	ь —	6.6 <sup>a</sup>	10/
	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.1 <sup>b</sup>	W
	T <sub>A</sub> = 70 °C		1.1 <sup>b</sup>	
Operating Junction and Storage Temperature Ra	ange	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b</sup>	Steady State	R <sub>thJA</sub>	33	40	°C/W		
Maximum Junction-to-Case	Steady State	R <sub>thJC</sub>	0.98	1.2	C/VV		

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface mounted on 1" x 1" FR4 board.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 60			V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		68		~~\//°C
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	i <sub>D</sub> = - 250 μA		- 5.2		mV/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 2.5	V
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = - 60 V, V <sub>GS</sub> = 0 V			- 1	μΑ
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 25			Α
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 3 A		0.055		
		$V_{GS} = -4.5 \text{ V}, I_D = -2 \text{ A}$		0.065		Ω
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 15 V, I <sub>D</sub> = - 5 A	20			S
Dynamic <sup>b</sup>			I.	•		
Input Capacitance	C <sub>iss</sub>			1500		pF
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		200		
Reverse Transfer Capacitance	C <sub>rss</sub>			150		
Tatal Oats Observe	0	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -5 \text{ A}$		38	56	nC
Total Gate Charge	Qg			19	30	
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -30 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -5 \text{ A}$		9		
Gate-Drain Charge	Q <sub>gd</sub>			10		
Gate Resistance	R <sub>g</sub>	f = 1 MHz		5.2		Ω
Turn-On Delay Time	t <sub>d(on)</sub>			10	15	
Rise Time	t <sub>r</sub>	$V_{DD} = -2 V$ , $R_L = 2 \Omega$		7	15	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 5 A, $V_{GEN}$ = - 10 V, $R_g$ = 1 $\Omega$		70	110	
Fall Time	t <sub>f</sub>			40	60	
<b>Drain-Source Body Diode Characteristic</b>	s					
Continuous Source-Drain Diode Current	I <sub>S</sub>	$T_C = 25  ^{\circ}C$			- 6.9	۸
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 15	A
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A		- 1	- 1.5	V
Body Diode Reverse Recovery Time t <sub>rr</sub>				45	68	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	L = 5 A di/dt = 10 A/vs T = 25 °C		59	120	nC
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -5 \text{ A}, \text{ di/dt} = 10 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		29		ns
Reverse Recovery Rise Time	t <sub>b</sub>			16		

#### Notes:

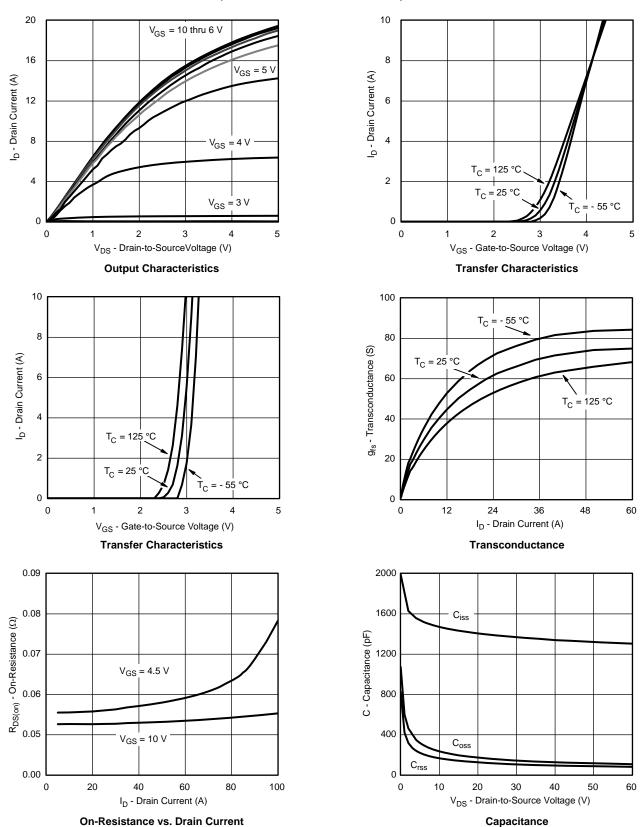
- a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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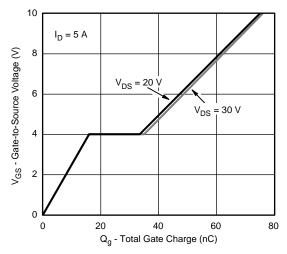
# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



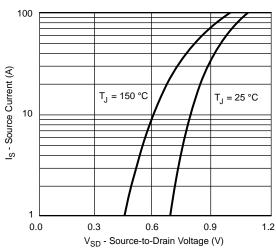
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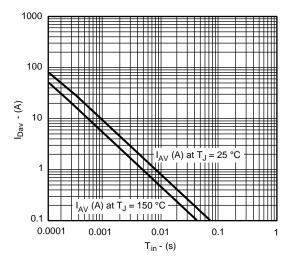
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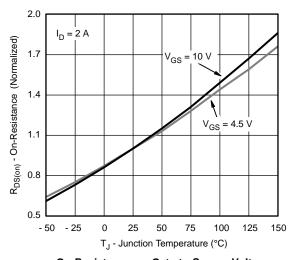




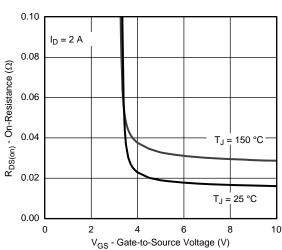
Source-Drain Diode Forward Voltage



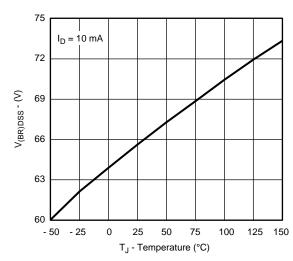
Single Pulse Avalanche Current Capability vs. Time



On-Resistance vs. Gate-to-Source Voltage



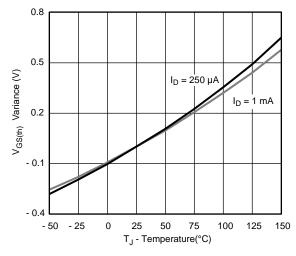
On-Resistance vs. Gate-to-Source Voltage

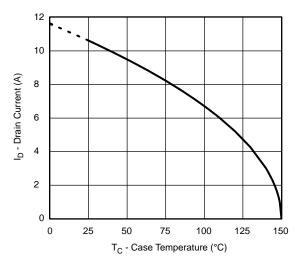


Drain-Source Breakdown Voltage vs. Junction Temperature

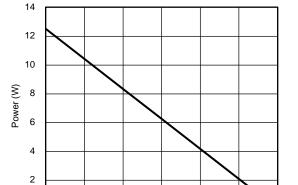


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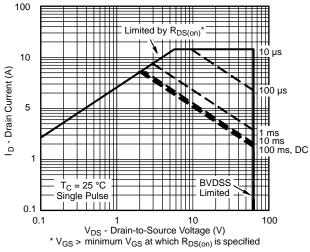








Max. Drain Current vs. Case Temperature



# $\label{eq:TJ-Temperature condition} T_J \text{ - Temperature (°C)}$ Power Derating, Junction-to-Case

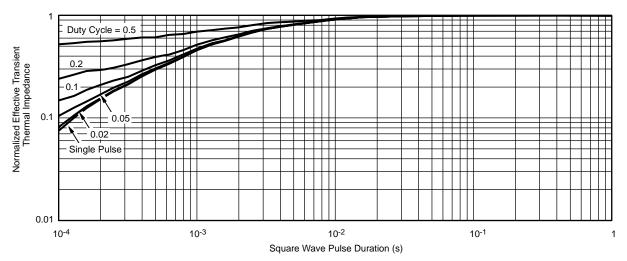
75

100

125

150





Normalized Thermal Transient Impedance, Junction-to-Case

0

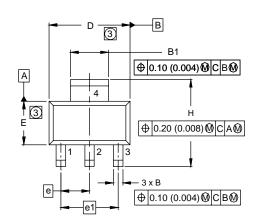
0

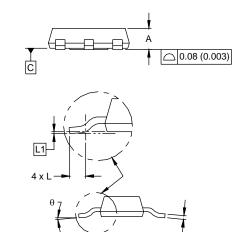
25

50



# **SOT-223 (HIGH VOLTAGE)**





DIM.	MILLIMETERS		INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	1.55	1.80	0.061	0.071	
В	0.65	0.85	0.026	0.033	
B1	2.95	3.15	0.116	0.124	
С	0.25	0.35	0.010	0.014	
D	6.30	6.70	0.248	0.264	
Е	3.30	3.70	0.130	0.146	
е	2.30 BSC		0.090	5 BSC	
e1	4.60 BSC		0.181	BSC	
Н	6.71	7.29	0.264	0.287	
L	0.91	-	0.036	-	
L1	0.061 BSC		0.0024	4 BSC	
θ	-	10'	-	10'	

ECN: S-82109-Rev. A, 15-Sep-08

DWG: 5969

### Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).
- 3. Dimension do not include mold flash.
- 4. Outline conforms to JEDEC outline TO-261AA.

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